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### Dimensions

Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
T	0.5mm +/-0.05mm
S	0.3mm MIN
B	0.3mm +/-0.1mm

### Packaging Specifications

Packaging	T&R, 330mm, Paper Tape
Packaging Quantity	50000

### General Information

Series	SMD Comm X5R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	1.21 mg
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	2.2 uF
Measurement Condition	1 kHz 0.5Vrms
Capacitance Tolerance	10%
Voltage DC	6.3 VDC
Dielectric Withstanding Voltage	15.75 VDC
Temperature Range	-55/+85°C
Temperature Coefficient	X5R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 0.2Vrms
Dissipation Factor	10% 1kHz 0.5Vrms
Aging Rate	5% Loss/Decade Hour: Referee Time is 48 Hours
Insulation Resistance	45.5 MOhms

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